

Part Number: XZFMDK20C-A

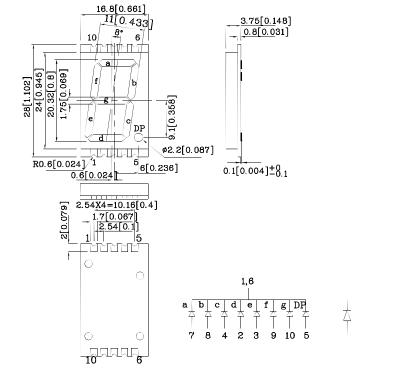
SURFACE MOUNT DISPLAY

Package Schematics

Features

- 0.8 inch digit height
- Robust package
- Low power consumption
- Standard configuration: Gray face w/ white segments
- Standard Package: 200pcs/ Reel
- MSL (Moisture Sensitivity Level): 2a
- RoHS compliant





Part

Number

XZFMDK20C-A

ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE

Notes:

DEVICES

- 1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25(0.01")$ unless otherwise noted. 2. Specifications are subject to change without notice.
- 3. The gap between the reflector and PCB shall not exceed 0.25mm.

Absolute Maximum Ratings (T _A =25°C)		Red (AlGaInP)	Unit
Reverse Voltage	V_{R}	5	V
Forward Current	$I_{\rm F}$	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i _{FS}	185	mA
Power Dissipation	P_{D}	75	mW
Operating Temperature	TA	$-40 \sim +85$	°C
Storage Temperature	Tstg	$-40 \sim +85$	÷C

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Red (AlGaInP)	Unit
Forward Voltage (Typ.) (I _F =10mA)	$V_{\rm F}$	1.85	V
Forward Voltage (Max.) (I _F =10mA)	$V_{\rm F}$	2.5	V
Reverse Current (Max.) (V _R =5V)	I_R	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =10mA)	λP	645*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =10mA)	λD	630*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)	$ riangle\lambda$	28	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	35	pF
Luminous Intensity Wavelength CIE127-2007* CIE127-2007* (I _F =10mA) ucd nm λP		Description	
min. typ.			
21000 46990 645*		Common Cathode	9,

*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards. Oct 13,2016

Emitting

Color

Red

Emitting

Material

AlGaInP

5600*

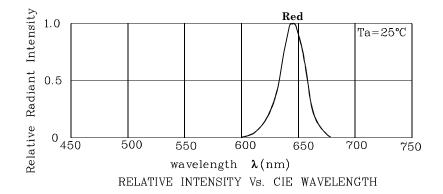
11990*

645*

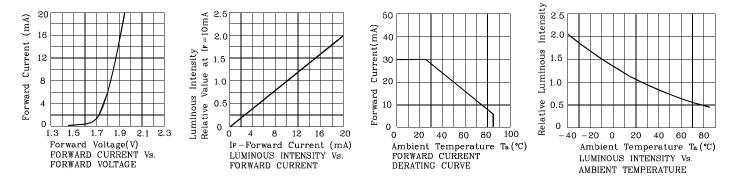
XDSB0266 V5-X Layout: Maggie L.

Rt.Hand Decimal.





✤ Red



LED is recommended for reflow soldering and soldering profile is shown below.

300 (°C) 10 s max 250 4°C/s C/s max 200 150~180 4°C/s max 150 Temperature 30~50s 80~120: 100 50 0 150 0 50 100 200 250 300 (sec) Time Notes:

Reflow Soldering Profile for SMD Products (Pb-Free Components)

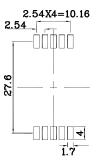
1. Maximum soldering temperature should not exceed 260°C

2. Recommended reflow temperature: 145°C-260°C 3. Do not put stress to the epoxy resin during

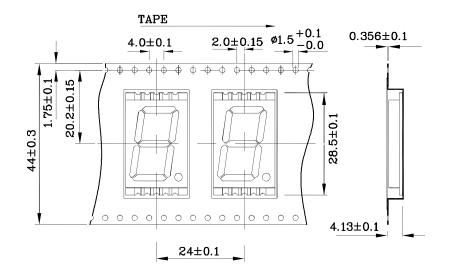
high temperatures conditions



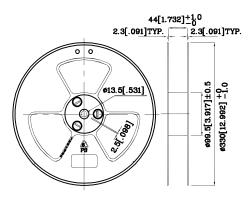
Recommended Soldering Pattern (Units : mm; Tolerance: ±0.15)



Tape Specification (Units : mm)



Reel Dimension



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

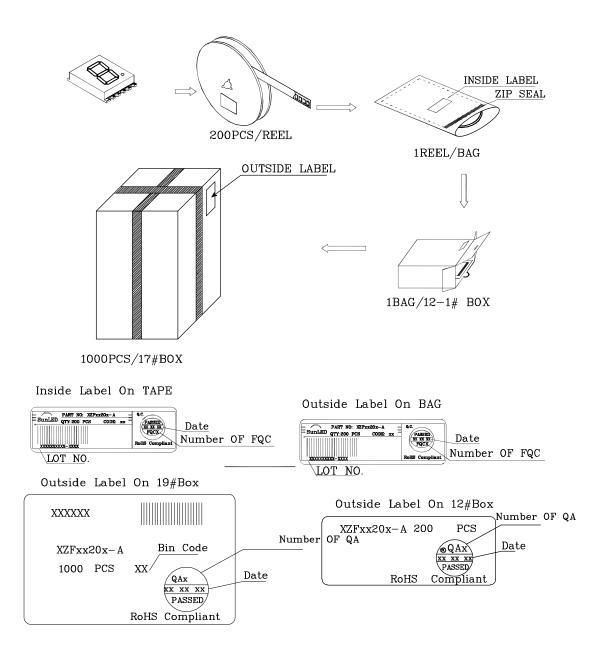
2. Luminous intensity / luminous flux: +/-15\%

3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please
- consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- $6. \ Additional \ technical \ notes \ are \ available \ at \ \underline{http://www.SunLEDusa.com/TechnicalNotes.asp}$